

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	29634	"1000" adj ppm	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 13:30
L2	2775	wafer near boat	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 13:30
L3	33	1 and 2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 13:33
L4	63	SiC with wafer near boat	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:14
L5	1	SiC with wafer near container	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 13:35
L6	0	4 same 1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 13:35
L7	0	4 with 1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 13:36
L8	0	4 and 1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 13:36
L9	0	2 with 1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:17
L10	85018	silicon adj carbide	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:17

L11	102	10 with 2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:24
L12	0	11 same 1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:18
L13	4	11 and 1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:18
L14	77408	surface adj roughness	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:25
L15	9	4 and 14	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:25
L16	1	11 and 15	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:27
L17	0	15 and 1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:28
L18	0	16 and 1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:28
L19	85018	silicon adj carbide	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:28
L20	76750	SiC	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:29

L21	102	19 with 2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:29
L22	63	20 with 2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:29
L23	147	21 22	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:29
L24	18	23 and 14	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:30
L25	8	24 and impurity	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:36
L26	818	wafer adj container	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:37
L27	2603	wafer adj boat	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:37
L28	82406	surface near roughness	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:38
L29	0	2 adj micron\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:39
L30	36020	"2" near micron\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:40

L31	335	28 with 30	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:40
L32	3	27 same 31	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:41
L33	0	26 same 31	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/01 14:40

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	372	wafer near boat	US-PGPUB	OR	OFF	2005/11/01 16:15
L2	212	wafer near container	US-PGPUB	OR	OFF	2005/11/01 16:15
L3	59	1.clm.	US-PGPUB	OR	OFF	2005/11/01 16:15
L4	64	2.clm.	US-PGPUB	OR	OFF	2005/11/01 16:15
L5	24918	impurity	US-PGPUB	OR	OFF	2005/11/01 16:16
L6	722	impurity with ppm	US-PGPUB	OR	OFF	2005/11/01 16:16
L7	805	part adj per adj million	US-PGPUB	OR	OFF	2005/11/01 16:16
L8	85	5 and 7	US-PGPUB	OR	OFF	2005/11/01 16:17
L9	5722	5.clm.	US-PGPUB	OR	OFF	2005/11/01 16:17
L10	85	7.clm.	US-PGPUB	OR	OFF	2005/11/01 16:18
L11	3	9 and 10	US-PGPUB	OR	OFF	2005/11/01 16:19
L12	0	1 and 11	US-PGPUB	OR	OFF	2005/11/01 16:18
L13	112	6.clm.	US-PGPUB	OR	OFF	2005/11/01 16:19
L14	2879	processing near component	US-PGPUB	OR	OFF	2005/11/01 16:19
L15	767	14.clm.	US-PGPUB	OR	OFF	2005/11/01 16:20
L16	3	15 and 13	US-PGPUB	OR	OFF	2005/11/01 16:20